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Renesas Electronics website: http://www.renesas.com

April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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Renesas Technology Corp. Customer Support Dept. April 1, 2003



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2SD1436(K)

Silicon NPN Triple Diffused

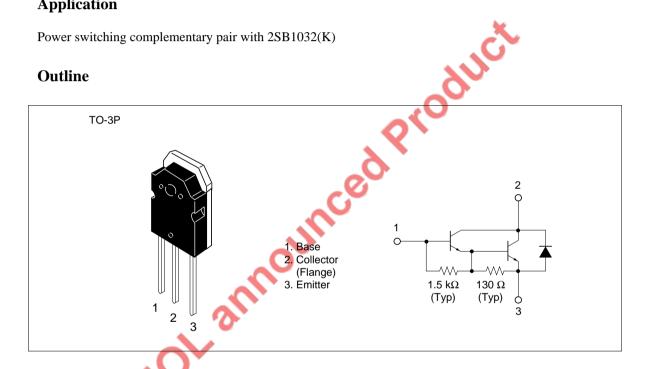


ADE-208-911 (Z) 1st. Edition September 2000

Application

Power switching complementary pair with 2SB1032(K)

Outline



2SD1436(K)

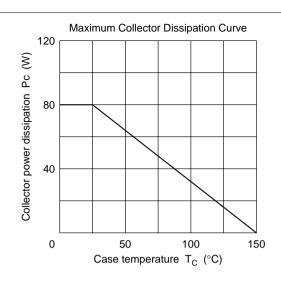
Absolute Maximum Ratings (Ta = 25°C)

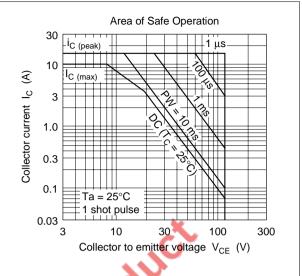
Unit
V
V
V
Α
Α
W
°C
℃

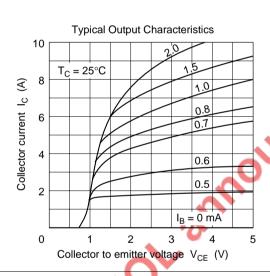
Electrical Characteristics ($Ta = 25^{\circ}C$)

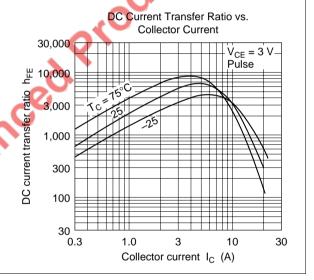
Storage temperature			Tstg	−55 to +150 C			
Note: 1. Value at $T_c = 25$ °C. Electrical Characteristics ($Ta = 25$ °C)							
Item	Symbol	Min	Тур	Max	Unit	Test conditions	
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	120	_	8	V	$I_{\rm C}$ = 25 mA, $R_{\rm BE}$ = ∞	
Emitter to base breakdown voltage	$V_{(BR)EBO}$	7	-	3	V	$I_{\rm E} = 200 \text{ mA}, I_{\rm C} = 0$	
Collector cutoff current	I _{CBO}	_		100	μΑ	$V_{CB} = 120 \text{ V}, I_{E} = 0$	
	I _{CEO}	-	<u> </u>	10	μΑ	$V_{CE} = 100 \text{ V}, R_{BE} = \infty$	
DC current transfer ratio	h _{FE}	1000	_	20000		$V_{CE} = 3 \text{ V}, I_{C} = 5 \text{ A}^{*1}$	
Collector to emitter saturation	V _{CE (sat)1}		_	1.5	V	$I_{\rm C} = 5 \text{ A}, I_{\rm B} = 10 \text{ mA}^{*1}$	
voltage	V _{CE (sat)2}	_	_	3.0	V	$I_{\rm C} = 10 \text{ A}, I_{\rm B} = 0.1 \text{ A}^{*1}$	
Base to emitter saturation	V _{BE (sat)1}	_	_	2.0	V	$I_C = 5 \text{ A}, I_B = 10 \text{ mA}^{*1}$	
voltage	V _{BE (sat)2}	_	_	3.5	V	$I_{\rm C} = 10 \text{ A}, I_{\rm B} = 0.1 \text{ A}^{*1}$	
Turn on time	Ton	_	0.8	_	μs	$I_{\rm C} = 5 \text{ A}, I_{\rm B1} = -I_{\rm B2} = 10 \text{ mA}$	
Turn off time	Toff	_	4.0	_	μs		

Note: 1. Pulse test.

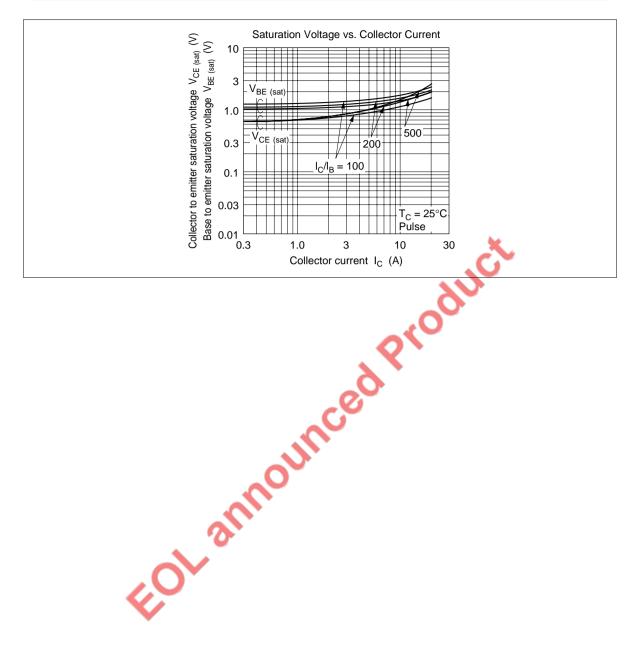








2SD1436(K)



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HITACHI

Hitachi, Ltd.

Semiconductor & IC Div. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100, Japan Tel: Tokyo (03) 3270-2111

Fax: (03) 3270-5109

For further information write to:

Hitachi America, Ltd. Semiconductor & IC Div. 2000 Sierra Point Parkway Brisbane, CA. 94005-1835 U S A

Tel: 415-589-8300 Fax: 415-583-4207 Hitachi Europe GmbH
Electronic Components Group
Continental Europe
Dornacher Straße 3
D-85622 Feldkirchen
München
Tel: 089-9 91 80-0

Tel: 089-9 91 80-0 Fax: 089-9 29 30 00 Hitachi Europe Ltd.
Electronic Components Div.
Northern Europe Headquarters
Whitebrook Park
Lower Cookham Road
Maidenhead
Berkshire SL6 8YA
United Kingdom

Tel: 0628-585000 Fax: 0628-778322 Hitachi Asia Pte. Ltd. 16 Collyer Quay #20-00 Hitachi Tower Singapore 0104 Tel: 535-2100 Fax: 535-1533

Hitachi Asia (Hong Kong) Ltd. Unit 706, North Tower, World Finance Centre, Harbour City, Canton Road Tsim Sha Tsui, Kowloon Hong Kong

Tel: 27359218 Fax: 27306071

